



DUAL SURFACE MOUNT SWITCHING DIODE

Features

- Fast Switching Speed ٠
- Surface Mount Package Ideally Suited for Automatic Insertion •
- For General Purpose Switching Applications
- High Conductance
- Lead Free/RoHS Compliant (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability •

Mechanical Data

- Case: SOT-23 •
- Case Material: Molded Plastic. UL Flammability • Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over . Alloy 42 leadframe).
- Polarity: See Diagram

 Marking Information: See Page 3 Ordering Information: See Page 3 	All Dimensions in mm											
 Ordering Information: See Page 3 Weight: 0.008 grams (approximate) 												
Vaximum Ratings @T _A = 25°C unless otherwise specified												
Characteristic	Symbol	Value	Unit V									
Non-Repetitive Peak Reverse Voltage	V _{RM}	100										
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	75	V									
RMS Reverse Voltage	V _{R(RMS)}	53	V									
Forward Continuous Current (Note 1)	I _{FM}	300	mA									
Non-Repetitive Peak Forward Surge Current $@ t = 1.0 \mu s$ @ t = 1.0s	I _{FSM}	2.0 1.0	A									
Power Dissipation (Note 1)	P _d	350	mW									
Thermal Resistance Junction to Ambient Air (Note 1)	$R_{ ext{ hetaJA}}$	357	°C/W									
Operating and Storage Temperature Range	T_{j} , T_{STG}	-65 to +150	°C									

TOF /IEV

۰D

Electrical Characteristics @T_A = 25°C unless otherwise specified

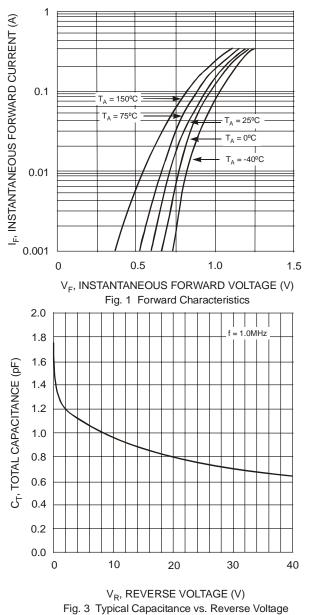
Characteristic	Symbol	Min	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 2)	V _{(BR)R}	75	_	V	I _R = 2.5μA		
Forward Voltage	V _F		0.715 0.855 1.0 1.25	V	$\begin{split} I_F &= 1.0 mA \\ I_F &= 10 mA \\ I_F &= 50 mA \\ I_F &= 150 mA \end{split}$		
Reverse Current (Note 2)	I _R		2.5 50 30 25	μΑ μΑ μΑ nA	$ \begin{array}{l} V_{R} = 75V \\ V_{R} = 75V, \ T_{i} = 150^{\circ}C \\ V_{R} = 25V, \ T_{i} = 150^{\circ}C \\ V_{R} = 20V \end{array} $		
Total Capacitance	C _T		2.0	pF	V _R = 0, f = 1.0MHz		
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_{F} = I_{R} = 10 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100 \Omega$		

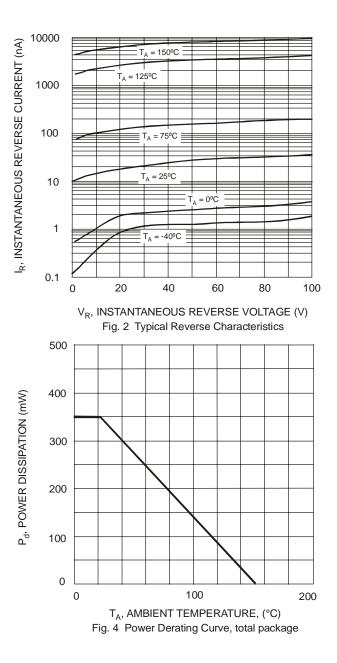
1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. Notes: Short duration test pulse used to minimize self-heating effect. 2.

3. No purposefully added lead.

SOT-23									
Dim	Min	Max							
Α	0.37	0.51							
В	1.20	1.40							
С	2.30	2.50							
D	0.89	1.03							
Е	0.45	0.60							
G	1.78	2.05							
н	2.80	3.00							
J	0.013	0.10							
к	0.903	1.10							
L	0.45	0.61							
М	0.085	0.180							
α	0°	8°							
All Din	All Dimensions in mm								







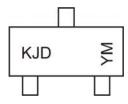


Ordering Information (Note 4)

Device	Packaging	Shipping
BAW56-7-F	SOT-23	3000/Tape & Reel

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



 $KJD = Product Type Marking Code \\ YM = Date Code Marking \\ Y = Year ex: N = 2002 \\ M = Month ex: 9 = September$

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	К	L	М	Ν	Р	R	s	Т	U	V	W	Х	Y	Z
Month	Jan	Fe	b I	Mar	Apr	May	Ju	n	Jul	Aug	Sep	Oc	t I	Nov	Dec
Code	1	2		3	4	5	6		7	8	9	0		Ν	D

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